In re: JPMorgan Treasury Futures Spoofing Litigation, No. 20 Civ. 03515 (S.D.N.Y.)

CME Data Request & Release

CME Group, Inc. Brookfield Place 300 Vesey Street New York, NY 10282

Re: In re JPMorgan Treasury Futures Spoofing Litigation, No. 20 Civ. 03515 (S.D.N.Y.)

To Whom It May Concern:

As part of the settlement administration procedures approved by the Court in the above-referenced matter, the undersigned agree to permit the CME Group, Inc. ("CME") to produce transaction data involving CBOT 2-year T-Note Futures, CBOT 3-year T-Note Futures, CBOT 5-year T-Note Futures, CBOT 10-year T-Note Futures, CBOT Ultra 10-year T-Note Futures, CBOT U.S. Treasury Bond Futures, or options on those futures, during the period of April 1, 2008 through January 31, 2016, associated with my and/or my firm's Tag50 ID(s) to Lowey Dannenberg, P.C. and Kirby McInerney LLP, counsel of record in the litigation captioned *In re JPMorgan Treasury Futures Spoofing Litigation*, No. 20 Civ. 03515 (S.D.N.Y.) (the "Action").

The relevant transaction data may contain transactions where the undersigned or its affiliated entities are a party. Below, the undersigned has provided the name(s), address(es), FCM firm(s), and account number(s) for those entities, and the associated Tag50 ID(s). The undersigned consents to having transactions produced to counsel of record in the Action without anonymization ("unmasked").

Name	Address	FCM Firm	FCM Account No.	Tag50(s)

The undersigned provides this consent with the understanding that the relevant materials will be produced with the designation "Highly Confidential," and will not be provided by the CME to anyone other than counsel of record in the Action. Notwithstanding the foregoing, the undersigned waives and hereby releases any claim that it may have against CME (and any of its subsidiaries or affiliates) based upon the release of the unmasked data to counsel of record in the Action.

If you require any additional information or have any questions regarding the foregoing, please don't hesitate to contact me.

Dated:	
	[Signature]
Print Nam or Firm Name	
Title	x:
Address	::
E-Mai	l:
Phone	: